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DATA SHEET

PART NO. : PC20H060AA

REV : A / 0

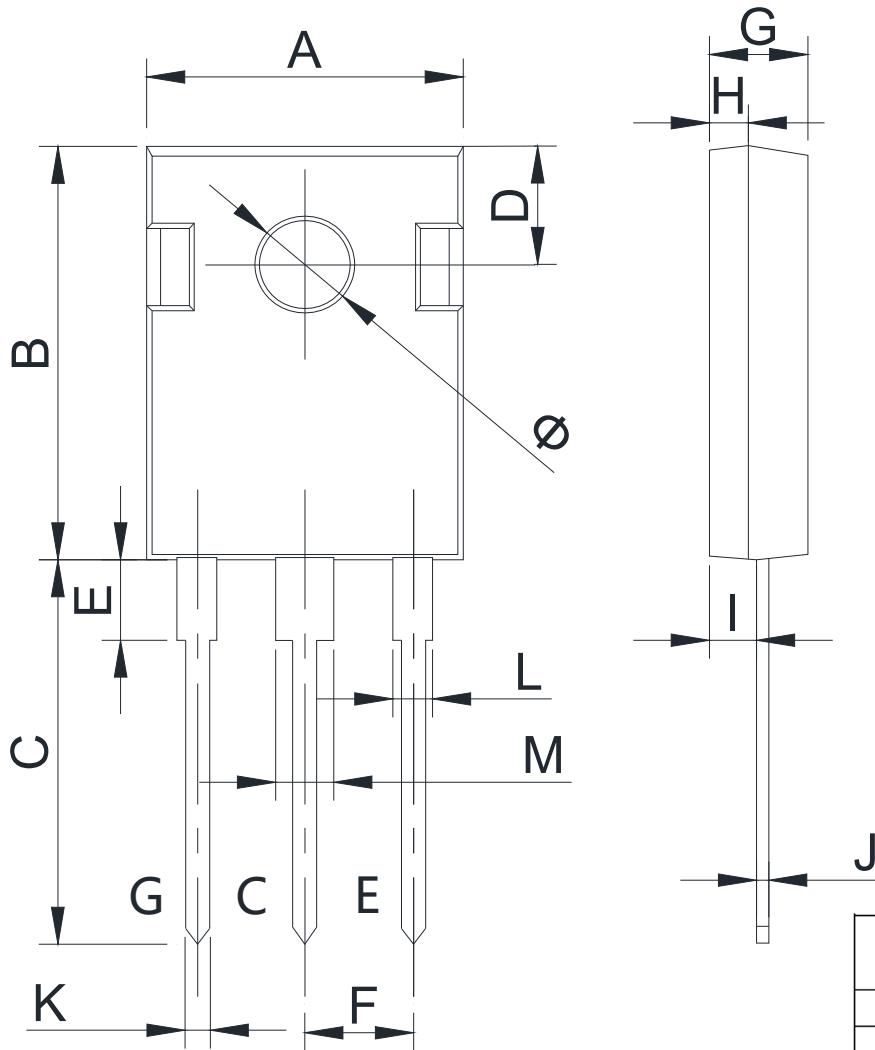
CUSTOMER'S APPROVAL : _____ DCC : _____

DRAWING NO. : DS-91P-23-0001

DATE : 2023-06-07

Page : 1

Package Dimensions



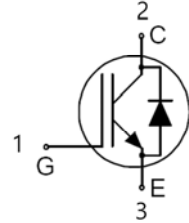
DIM	MILLIMETERS	
	MIN	MAX
A	15.75	15.85
B	20.9	21.05
C	19.85	20.05
D	5.75	5.85
E	4.15	4.25
F	5.44BSC.	
G	4.95	5.05
H	1.97	2.03
I	2.35	2.45
J	0.6	0.65
K	1.17	1.25
L	1.95	2.05
M	2.85	3.11
ϕ	3.5	3.7

Features

600V, 20A

$V_{CE(sat)(typ.)} = 1.70V$, $I_C = 20A$

Maximum Junction Temperature 175°C

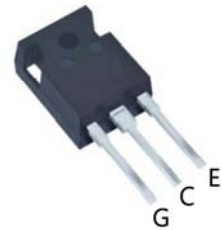


Applications

Motor control

Key Performance and Package Parameters

V_{CE}	I_C	$V_{CEsat}, T_{vj}=25^{\circ}C$	T_{vjmax}
600V	20A	1.7V	175°C



Absolute Maximum Ratings

Symbol	Parameter	Value	Unit
V_{CES}	Collector-Emitter Voltage($T_{vj}=25^{\circ}C$)	600	V
V_{GES}	Gate-Emitter Voltage($T_{vj}=25^{\circ}C$)	± 30	V
I_C	Continuous Collector Current($T_C = 25^{\circ}C$)	40	A
	Continuous Collector Current ($T_C = 100^{\circ}C$)	20	A
I_{CM}	Pulsed Collector Current (Note 1) ($T_{vj} \leq 175^{\circ}C$)	80	A
I_F	Diode Forward Current ($T_C = 25^{\circ}C$)	40	A
	Diode Forward Current ($T_C = 100^{\circ}C$)	20	A
I_{FRM}	Diode pulsed current($T_{vj} \leq 175^{\circ}C$)	80	A
P_D	Maximum Power Dissipation ($T_C=25^{\circ}C$)	176	W
T_J	Operating Junction Temperature Range	-40 to 175	°C
T_{STG}	Storage Temperature Range	-50 to 150	°C

Thermal Data

Symbol	Parameter	Max.	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case for IGBT	0.85	K/W
$R_{\theta JC}$	Thermal Resistance, Junction to Case for Diode	1.4	K/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	40	K/W

Electrical Characteristics (Tc=25°C unless otherwise noted.)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{CES}	Collector-Emitter Breakdown Voltage	$V_{GE} = 0V$, $I_C = 0.5mA$, $T_{vj} = 25^\circ C$	600	---	---	V
I_{CES}	Collector-Emitter Leakage Current	$V_{CE} = 600V$, $V_{GE} = 0V$, $T_{vj} = 175^\circ C$	---	---	300	μA
I_{GES}	Gate Leakage Current, Forward	$V_{GE} = 30V$, $V_{CE} = 0V$, $T_{vj} = 125^\circ C$	-200	---	+200	nA
$V_{GE(th)}$	Gate Threshold Voltage	$V_{GE} = V_{CE}$, $I_C = 1mA$, $T_{vj} = 25^\circ C$	4.5	5.6	6.5	V
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$V_{GE} = 15V$, $I_C = 20A$, $T_{vj} = 25^\circ C$	---	1.7	2.1	V
		$V_{GE} = 0V$, $I_C = 20A$, $T_{vj} = 175^\circ C$	---	2.2	---	V
Q_G	Total Gate Charge	$I_C = 20A$, $V_{CE} = 480V$, $V_{GE} = 15V$, $T_{vj} = 25^\circ C$	---	73	---	nC
Q_{GE}	Gate-Emitter Charge		---	9	---	nC
Q_{GC}	Gate-Collector Charge		---	38	---	nC
$t_{d(on)}$	Turn-on Delay Time($T_{vj} = 25^\circ C$)	$V_{CC} = 400V$ $I_C = 20A$ $R_{G(on)} = 10\Omega$ $R_{G(off)} = 10\Omega$ $C = 0nF$ $V_{GE} = 15V$ $L_{load} = 400\mu H$	---	27	---	ns
	Turn-on Delay Time($T_{vj} = 175^\circ C$)		---	26	---	ns
t_r	Turn-on Rise Time($T_{vj} = 25^\circ C$)		---	33	---	ns
	Turn-on Rise Time($T_{vj} = 175^\circ C$)		---	37	---	ns
$t_{d(off)}$	Turn-off Delay Time($T_{vj} = 25^\circ C$)		---	109	---	ns
	Turn-off Delay Time($T_{vj} = 175^\circ C$)		---	140	---	ns
t_f	Turn-off Fall Time($T_{vj} = 25^\circ C$)		---	45	---	ns
	Turn-off Fall Time($T_{vj} = 175^\circ C$)		---	94	---	ns
E_{on}	Turn-on Switching Loss($T_{vj} = 25^\circ C$)		---	480	---	mJ
	Turn-on Switching Loss($T_{vj} = 175^\circ C$)		---	956	---	mJ
E_{off}	Turn-off Switching Loss($T_{vj} = 25^\circ C$)		---	353	---	mJ
	Turn-off Switching Loss($T_{vj} = 175^\circ C$)		---	600	---	mJ



Trench Field-Stop Technology IGBT

PC20H060AA

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Electrical Characteristics (Tc=25°C unless otherwise noted.)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
C _{ies}	Input Capacitance	V _{GE} = 0V, V _{CE} = 25V, f = 1MHz, T _{vj} = 25°C	---	1230	---	pF
C _{oes}	Output Capacitance		---	57	---	pF
C _{res}	Reverse Transfer Capacitance		---	30	---	pF
R _g	Internal gate resistor		---	0	---	Ω

Diode Characteristics (TC=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ.	Max	Unit	
V _F	Diode Forward Voltage	V _{GE} =0V, I _F =20A, T _{vj} =25°C	---	1.5	2.2	V	
		V _{GE} =0V, I _F =20A, T _{vj} =175°C	---	1.35	---	V	
t _{rr}	Diode Reverse Recovery Time	I _F = 20A, V _R =400V, di _F /dt=-500A/μs	T _{vj} =25°C	---	100	---	ns
	Diode Reverse Recovery Time		T _{vj} =175°C	---	211	---	ns
Q _{rr}	Diode Reverse Recovery Charge		T _{vj} =25°C	---	390	---	nC
			T _{vj} =175°C	---	1449	---	
I _{rr}	Diode peak Reverse Recovery Current		T _{vj} =25°C	---	8	---	A
	Diode peak Reverse Recovery Current		T _{vj} =175°C	---	15	---	A
di _{rr} /dt	Peak rate of i _{rr}		T _{vj} =25°C	---	119	---	A/μs
	Peak rate of i _{rr}		T _{vj} =175°C	---	172	---	A/μs
E _{rec}	Reverse recovery energy		T _{vj} =25°C	---	79	---	μJ
	Reverse recovery energy		T _{vj} =175°C	---	316	---	μJ

Note1: Repetitive rating, pulse width limited by maximum junction temperature



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Typical Characteristics

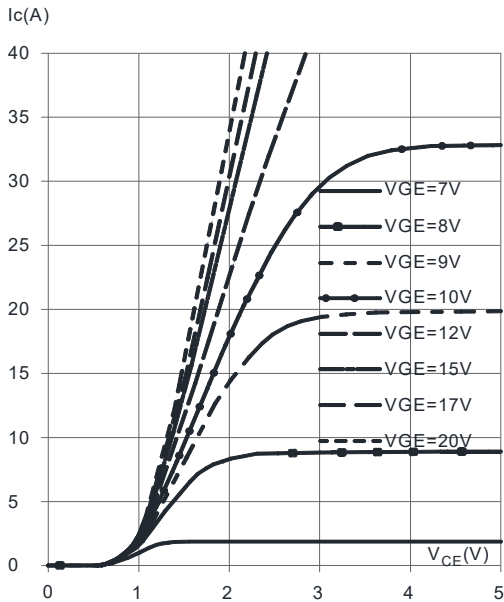


Fig. 1 Typical Output Characteristic ($T_c=25^\circ\text{C}$)

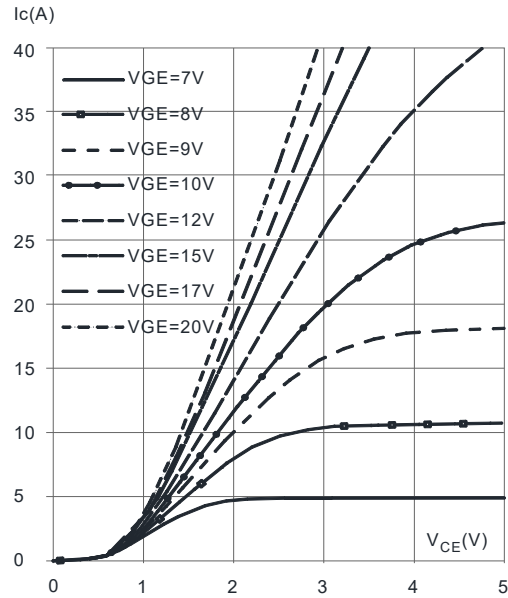


Fig. 2 Typical Output Characteristic ($T_c=175^\circ\text{C}$)

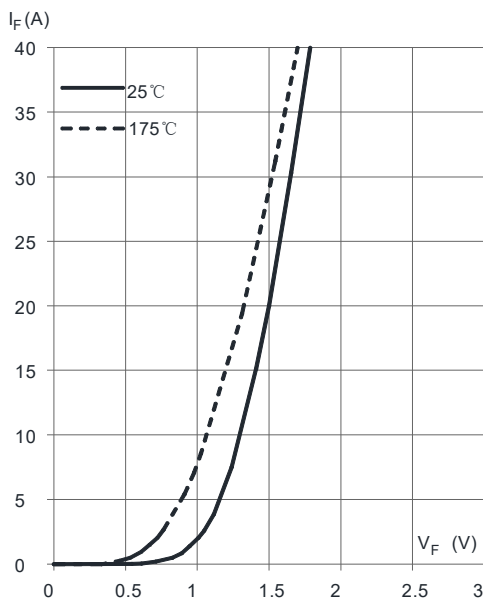


Fig. 3 Typical I_F as a function of V_F

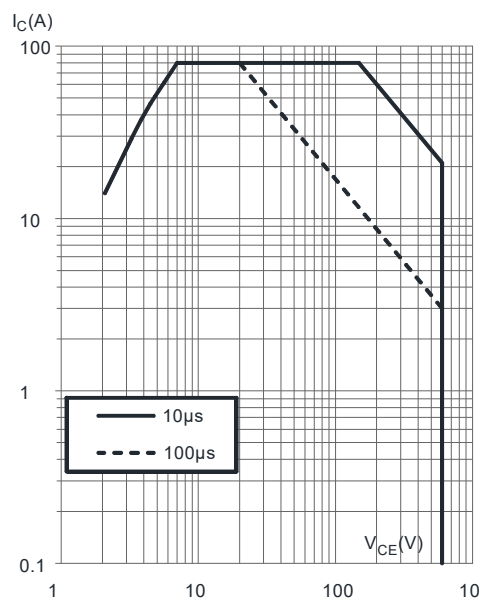


Fig. 4 Forward bias safe operating area

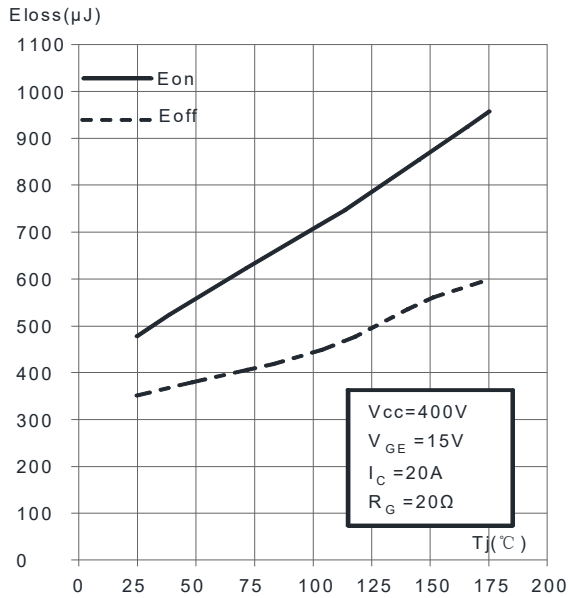


Fig. 5 Typical switching losses as T_j

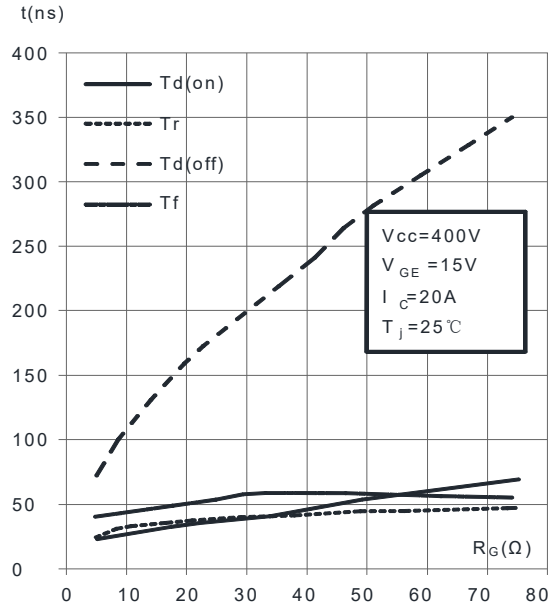


Fig. 6 Switching times as R_G

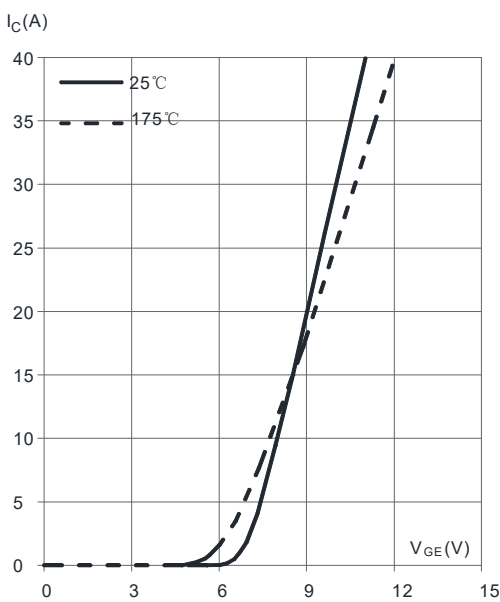


Fig. 7 Typical transfer characteristic

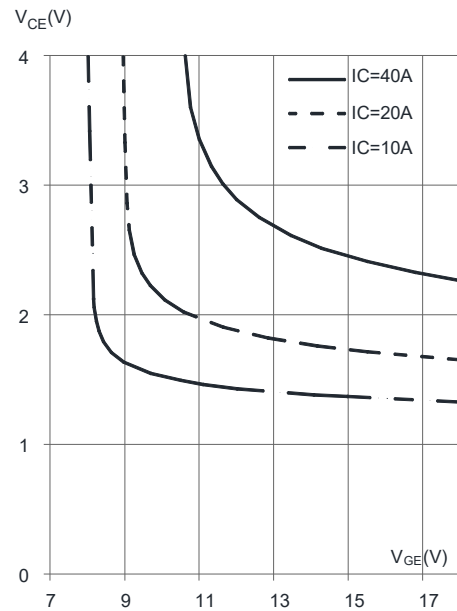


Fig. 8 Typical V_{CE} as a function of V_{GE}

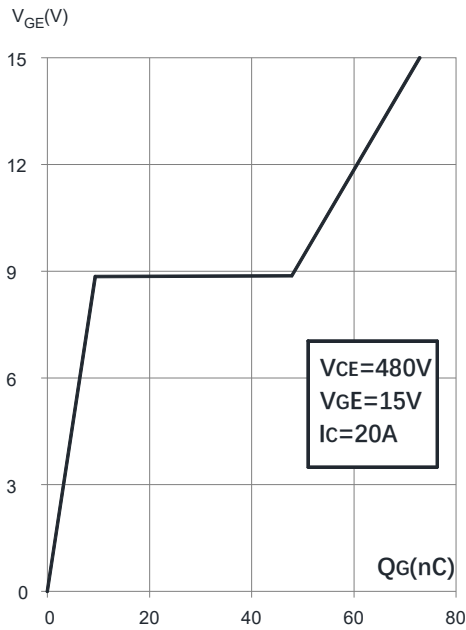


Fig. 5 Typical gate charge

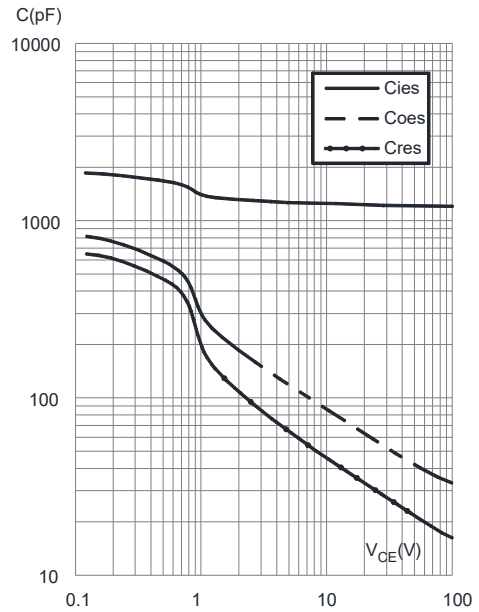


Fig. 6 Capacitance as a function of Vce

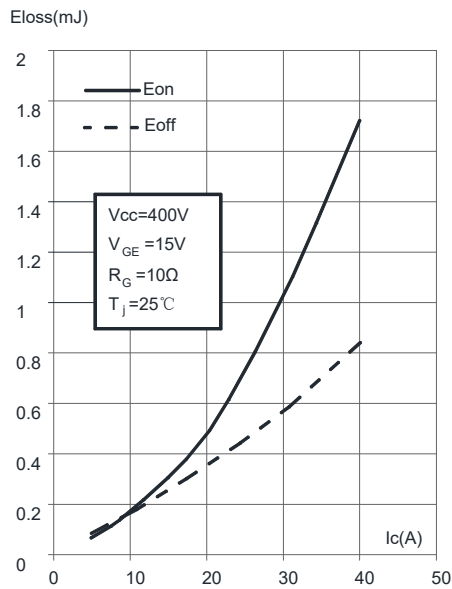


Fig. 7 Typical switching losses as I_C

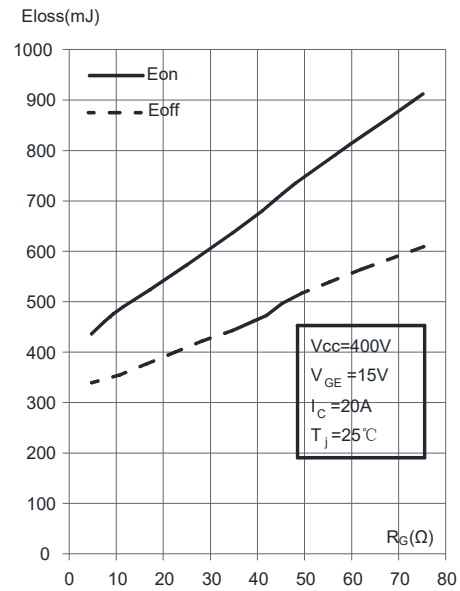


Fig. 8 Typical switching losses as R_G



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● PART NO. SYSTEM :

P C 15 H 120 A C

